

# MT90823 3V Large Digital Switch

Data Sheet

## Features

- 2,048  $\times$  2,048 channel non-blocking switching at 8.192 Mb/s
- Per-channel variable or constant throughput delay
- Automatic identification of ST-BUS/GCI interfaces
- Accept ST-BUS streams of 2.048, 4.096 or 8.192 Mb/s
- Automatic frame offset delay measurement
- Per-stream frame delay offset programming
- Per-channel high impedance output control
- Per-channel message mode
- Control interface compatible to Motorola nonmultiplexed CPUs
- · Connection memory block programming
- 3.3V local I/O with 5V tolerant inputs and TTLcompatible outputs
- IEEE-1149.1 (JTAG) Test Port

# Applications

- Medium and large switching platforms
- CTI application
- Voice/data multiplexer
- · Digital cross connects
- ST-BUS/GCI interface functions
- Support IEEE 802.9a standard

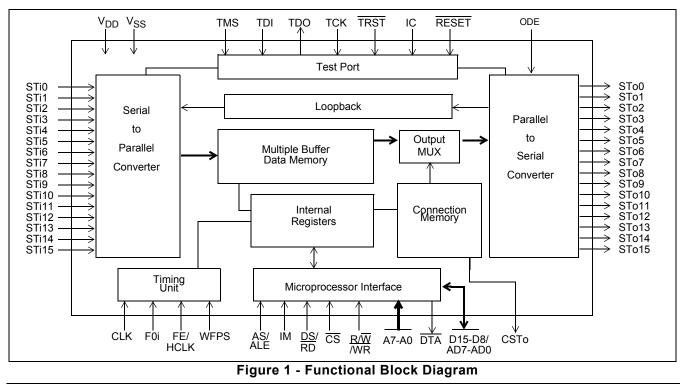
|  | February 2003   |
|--|---|
| Ordering   | g Information   |
| MT90823AP<br>MT90823AL<br>MT90823AB<br>MT90823AG | 84 Pin PLCC<br>100 Pin MQFP<br>100 Pin LQFP<br>120 Pin PBGA |
| -40°C t/   | o +85°C   |

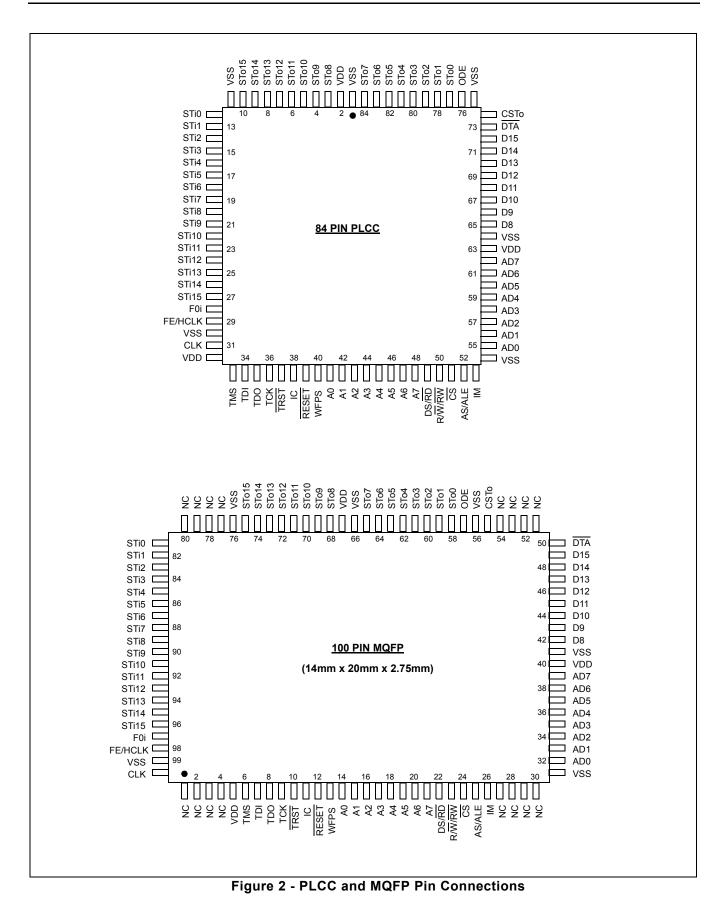
## Description

The MT90823 Large Digital Switch has a non-blocking switch capacity of: 2,048 x 2,048 channels at a serial bit rate of 8.192 Mb/s; 1,024 x 1,024 channels at 4.096 Mb/s; and 512 x 512 channels at 2.048 Mb/s. The device has many features that are programmable on a per stream or per channel basis, including message mode, input offset delay and high impedance output control.

Per stream input delay control is particularly useful for managing large multi-chip switches that transport both voice channel and concatenated data channels.

In addition, the input stream can be individually calibrated for input frame offset using a dedicated pin.





Zarlink Semiconductor Inc.

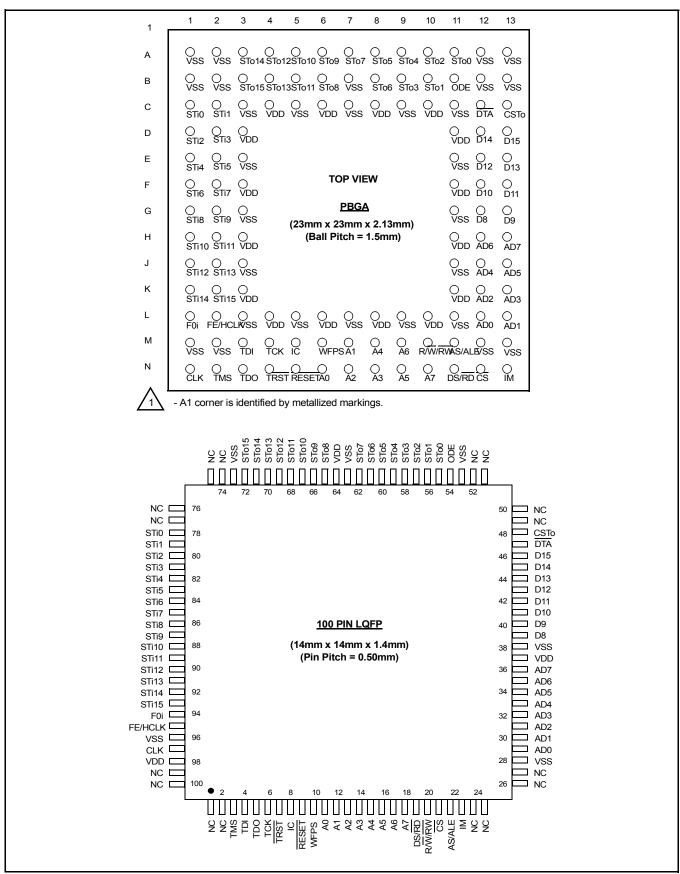


Figure 3 - PBGA and LQFP Pin Connections

# **Pin Description**

|                            | Pin #                        |                                       |  |                 |  |
|----------------------------|------------------------------|---------------------------------------|--|-----------------|--|
| 84<br>PLCC                 | 100<br>MQFP                  | 100<br>LQFP                           | 120<br>BGA   | Name            | Description  |
| 1, 11,<br>30, 54<br>64, 75 | 31, 41,<br>56, 66,<br>76, 99 | 28,<br>38,<br>53,<br>63,<br>73,<br>96 | A1,A2,A12,A13,<br>B1,B2,B7,B12,<br>B13,C3,C5,C7,<br>C9,C11,E3,E11<br>G3,G11,J3,J11,<br>L3,L5,L7,L9,L11,<br>M1,M2,M12,M13 | V <sub>SS</sub> | Ground.  |
| 2, 32,<br>63               | 5, 40,<br>67                 | 37,<br>64,98                          | C4,C6,C8,C10,<br>D3,D11,F3,F11,<br>H3,H11,K3,K11,<br>L4,L6,L8,L10  | V <sub>DD</sub> | +3.3 Volt Power Supply.  |
| 3 - 10                     | 68-75                        | 65 -<br>72                            | B6,A6,A5,B5,A4,<br>B4,A3,B3  | STo8 - 15       | <b>ST-BUS Output 8 to 15 (5V Tolerant Three-state Outputs):</b> Serial data Output stream. These streams may have data rates of 2.048, 4.096 or 8.192 Mb/s, depending upon the value programmed at bits DR0 - 1 in the IMS register.   |
| 12 -<br>27                 | 81-96                        | 78 -<br>93                            | C1,C2,D1,D2,E1,<br>E2,F1,F2,G1,G2,<br>H1,H2,J1,J2,K1,<br>K2  | STi0 - 15       | <b>ST-BUS Input 0 to 15 (5V Tolerant Inputs):</b> Serial data input stream. These streams may have data rates of 2.048, 4.096 or 8.192 Mb/s, depending upon the value programmed at bits DR0 - 1 in the IMS register.  |
| 28                         | 97                           | 94                                    | L1   | F0i             | <b>Frame Pulse (5V Tolerant Input):</b> When the WFPS pin is low, this input accepts and automatically identifies frame synchronization signals formatted according to ST-BUS and GCI specifications. When the WFPS pin is high, this pin accepts a negative frame pulse which conforms to WFPS formats. |
| 29                         | 98                           | 95                                    | L2   | FE/HCLK         | <b>Frame Evaluation / HCLK Clock (5V Tolerant Input):</b><br>When the WFPS pin is low, this pin is the frame<br>measurement input. When the WFPS pin is high, the<br>HCLK (4.096MHz clock) is required for frame<br>alignment in the wide frame pulse (WFP) mode.  |
| 31                         | 100                          | 97                                    | N1   | CLK             | <b>Clock (5V Tolerant Input):</b> Serial clock for shifting data in/out on the serial streams (STi/o 0 - 15). Depending upon the value programmed at bits DR0 - 1 in the IMS register, this input accepts a 4.096, 8.192 or 16.384 MHz clock.  |
| 33                         | 6                            | 3                                     | N2   | TMS             | <b>Test Mode Select (3.3V Input with internal pull-up):</b><br>JTAG signal that controls the TAP controller state<br>transitions.  |
| 34                         | 7                            | 4                                     | М3   | TDI             | <b>Test Serial Data In (3.3V Tolerant Input with internal pull-up):</b> JTAG serial test instructions and data are shifted in on this pin.   |

# **Pin Description (continued)**

|            | Pin #       |             |                              |         |  |
|------------|-------------|-------------|------------------------------|---------|--|
| 84<br>PLCC | 100<br>MQFP | 100<br>LQFP | 120<br>BGA                   | Name    | Description  |
| 35         | 8           | 5           | N3                           | TDO     | <b>Test Serial Data Out (3.3V Output):</b> JTAG serial data is output on this pin on the falling edge of TCK. This pin is held in high impedance state when JTAG scan is not enabled.  |
| 36         | 9           | 6           | M4                           | TCK     | <b>Test Clock (5V Tolerant Input):</b> Provides the clock to the JTAG test logic.  |
| 37         | 10          | 7           | N4                           | TRST    | <b>Test Reset (3.3V Input with internal pull-up):</b><br>Asynchronously initializes the JTAG TAP controller by<br>putting it in the Test-Logic-Reset state. This pin should<br>be pulsed low on power-up, or held low, to ensure that<br>the MT90823 is in the normal functional mode.   |
| 38         | 11          | 8           | M5                           | IC      | <b>Internal Connection (3.3V Input with internal pull-<br/>down):</b> Connect to V <sub>SS</sub> for normal operation. This pin<br>must be low for the MT90823 to function normally and<br>to comply with IEEE 1149 (JTAG) boundary scan<br>requirements.  |
| 39         | 12          | 9           | N5                           | RESET   | <b>Device Reset (5V Tolerant Input):</b> This input (active LOW) puts the MT90823 in its reset state to clear the device internal counters, registers and bring STo0 - 15 and microport data outputs to a high impedance state. The time constant for a power up reset circuit must be a minimum of five times the rise time of the power supply. In normal operation, the RESET pin must be held low for a minimum of 100nsec to reset the device.  |
| 40         | 13          | 10          | M6                           | WFPS    | Wide Frame Pulse Select (5V Tolerant Input): When<br>1, enables the wide frame pulse (WFP) Frame<br>Alignment interface. When 0, the device operates in<br>ST-BUS/GCI mode.  |
| 41 -<br>48 | 14-21       | 11 -<br>18  | N6,M7,N7,N8,<br>M8,N9,M9,N10 | A0 - A7 | Address 0 - 7 (5V Tolerant Input): When non-<br>multiplexed CPU bus operation is selected, these lines<br>provide the A0 - A7 address lines to the internal<br>memories.   |
| 49         | 22          | 19          | N11                          | DS/RD   | <b>Data Strobe / Read (5V Tolerant Input):</b> For Motorola multiplexed bus operation, this input is DS. This active high DS input works in conjunction with CS to enable the read and write operations.<br>For Motorola non-multiplexed CPU bus operation, this input is DS. This active low input works in conjunction with CS to enable the read and write operations.<br>For multiplexed bus operation, this input is RD. This active low input sets the data bus lines (AD0-AD7, D8-D15) as outputs. |

# **Pin Description (continued)**

|            | Pin #       |             |   |          |   |
|------------|-------------|-------------|---|----------|---|
| 84<br>PLCC | 100<br>MQFP | 100<br>LQFP | 120<br>BGA                              | Name     | Description   |
| 50         | 23          | 20          | M10                                     | R/W / WR | <b>Read/Write / Write (5V Tolerant Input):</b> In the cases<br>of Motorola non-multiplexed and multiplexed bus<br>operations, this input is R/W. This input controls the<br>direction of the data bus lines (AD0 - AD7, D8-D15)<br>during a microprocessor access.<br>For multiplexed bus operation, this input is WR. This<br>active low input is used with RD to control the data bus<br>(AD0 - 7) lines as inputs. |
| 51         | 24          | 21          | N12                                     | CS       | <b>Chip Select (5V Tolerant Input):</b> Active low input used by a microprocessor to activate the microprocessor port of MT90823.   |
| 52         | 25          | 22          | M11                                     | AS/ALE   | Address Strobe or Latch Enable (5V Tolerant<br>Input): This input is used if multiplexed bus operation<br>is selected via the IM input pin. For Motorola non-<br>multiplexed bus operation, connect this pin to ground.   |
| 53         | 26          | 23          | N13                                     | IM       | <b>CPU Interface Mode (5V Tolerant Input):</b> When IM is high, the microprocessor port is in the multiplexed mode. When IM is low, the microprocessor port is in non-multiplexed mode.   |
| 55 -<br>62 | 32-39       | 29 -<br>36  | L12,L13,K12,<br>K13,J12,J13,<br>H12,H13 | AD0 - 7  | Address/Data Bus 0 to 7 (5V Tolerant I/O): These<br>pins are the eight least significant data bits of the<br>microprocessor port. In multiplexed mode, these pins<br>are also the input address bits of the microprocessor<br>port.   |
| 65 -<br>72 | 42-49       | 39 -<br>46  | G12,G13,F12,<br>F13,E12,E13,<br>D12,D13 | D8 - 15  | <b>Data Bus 8-15 (5V Tolerant I/O):</b> These pins are the eight most significant data bits of the microprocessor port.   |
| 73         | 50          | 47          | C12                                     | DTA      | Data Transfer Acknowledgement (5V tolerant<br>Three-state Output): Indicates that a data bus transfer<br>is complete. When the bus cycle ends, this pin drives<br>HIGH and then tri-states, allowing for faster bus cycles<br>with a weaker pull-up resistor. A pull-up resistor is<br>required to hold a HIGH level when the pin is tri-stated.  |
| 74         | 55          | 48          | C13                                     | CSTo     | <b>Control Output (5V Tolerant Output).</b> This is a 4.096, 8.192 or 16.384 Mb/s output containing 512, 1024 or 2048 bits per frame respectively. The level of each bit is determined by the CSTo bit in the connection memory. See External Drive Control Section.  |

## **Pin Description (continued)**

|            | Pin #   |  |                                |          |   |  |
|------------|---|--|--------------------------------|----------|---|--|
| 84<br>PLCC | 100<br>MQFP                                       | 100<br>LQFP  | 120<br>BGA                     | Name     | Description   |  |
| 76         | 57  | 54   | B11                            | ODE      | <b>Output Drive Enable (5V Tolerant Input):</b> This is the output enable control for the STo0-15 serial outputs. When ODE input is low and the OSB bit of the IMS register is low, STo0-15 are in a high impedance state. If this input is high, the STo0-15 output drivers are enabled. However, each channel may still be put into a high impedance state by using the per channel control bit in the connection memory. |  |
| 77 -<br>84 | 58-65   | 55 -<br>62   | A11,B10,A10,B9,<br>A9,A8,B8,A7 | STo0 - 7 | Data Stream Output 0 to 7 (5V Tolerant Three-state Outputs): Serial data Output stream. These streams have selectable data rates of 2.048, 4.096 or 8.192 Mb/s.   |  |
| -          | 1 - 4,<br>27 -<br>30,<br>51 -<br>54<br>77 -<br>80 | 1 - 2,<br>24 -<br>27,<br>49 -<br>52,<br>74 -<br>77,<br>99 -<br>100 |                                | NC       | No connection.  |  |

## **Device Overview**

The MT90823 Large Digital Switch is capable of switching up to  $2,048 \times 2,048$  channels. The MT90823 is designed to switch 64 kb/s PCM or N x 64 kb/s data. The device maintains frame integrity in data applications and minimum throughput delay for voice applications on a per channel basis.

The serial input streams of the MT90823 can have a bit rate of 2.048, 4.096 or 8.192 Mbit/s and are arranged in  $125\mu$ s wide frames, which contain 32, 64 or 128 channels, respectively. The data rates on input and output streams are identical.

By using Mitel's message mode capability, the microprocessor can access input and output time-slots on a per channel basis. This feature is useful for transferring control and status information for external circuits or other ST-BUS devices. The MT90823 automatically identifies the polarity of the frame synchronization input signal and configures its serial streams to be compatible to either ST-BUS or GCI formats.

Two different microprocessor bus interfaces can be selected through the Input Mode pin (IM): Non-multiplexed or Multiplexed. These interfaces provide compatibility with multiplexed and Motorola multiplexed/non-multiplexed buses.

The frame offset calibration function allows users to measure the frame offset delay using a frame evaluation pin (FE). The input offset delay can be programmed for individual streams using internal frame input offset registers, see Table 11.

The internal loopback allows the ST-BUS output data to be looped around to the ST-BUS inputs for diagnostic purposes.

# **Functional Description**

A functional Block Diagram of the MT90823 is shown in Figure 1.

#### **Data and Connection Memory**

For all data rates, the received serial data is converted to parallel format by internal serial-to-parallel converters and stored sequentially in the data memory. Depending upon the selected operation programmed in the interface mode select (IMS) register, the useable data memory may be as large as 2,048 bytes. The sequential addressing of the data memory is performed by an internal counter, which is reset by the input 8 kHz frame pulse (F0i) to mark the frame boundaries of the incoming serial data streams.

Data to be output on the serial streams may come from either the data memory or connection memory. Locations in the connection memory are associated with particular ST-BUS output channels. When a channel is due to be transmitted on an ST-BUS output, the data for this channel can be switched either from an ST-BUS input in connection mode, or from the lower half of the connection memory in message mode. Data destined for a particular channel on a serial output stream is read from the data memory or connection memory during the previous channel time-slot. This allows enough time for memory access and parallel-to-serial conversion.

#### **Connection and Message Modes**

In the connection mode, the addresses of the input source data for all output channels are stored in the connection memory. The connection memory is mapped in such a way that each location corresponds to an output channel on the output streams. For details on the use of the source address data (CAB and SAB bits), see Table 13 and Table 14. Once the source address bits are programmed by the microprocessor, the contents of the data memory at the selected address are transferred to the parallel-to-serial converters and then onto an ST-BUS output stream.

By having several output channels connected to the same input source channel, data can be broadcasted from one input channel to several output channels.

In message mode, the microprocessor writes data to the connection memory locations corresponding to the output stream and channel number. The lower half (8 least significant bits) of the connection memory content is transferred directly to the parallel-to-serial converter. This data will be output on the ST-BUS streams in every frame until the data is changed by the microprocessor.

The five most significant bits of the connection memory controls the following for an output channel: message or connection mode; constant or variable delay; enables/tristate the ST-BUS output drivers; and, enables/disable the loopback function. In ad- dition, one of these bits allows the user to control the CSTo output.

If an output channel is set to a high-impedance state through the connection memory, the ST-BUS output

will be in a high impedance state for the duration of that channel. In addition to the per-channel control, all channels on the ST-BUS outputs can be placed in a high impedance state by either pulling the ODE input pin low or programming the output standby (OSB) bit in the interface mode selection register to low. This action overrides the individual per-channel programming by the connection memory bits.

The connection memory data can be accessed via the microprocessor interface through the D0 to D15 pins. The addressing of the device internal registers, data and connection memories is performed through the address input pins and the Memory Select (MS) bit of the control register. For details on device addressing, see Software Control and Control Register bits description (Tables 4, 6 and 7).

#### Serial Data Interface Timing

The master clock frequency must always be twice the data rate. The master clock (CLK) must be either at 4.096, 8.192 or 16.384 MHz for serial data rate of 2.048, 4.096 or 8.192 Mb/s respectively. The input and output stream data rates will always be identical.

The MT90823 provides two different interface timing modes controlled by the WFPS pin. If the WFPS pin is low, the MT90823 is in ST-BUS/GCI mode. If the WFPS pin is high, the MT90823 is in the wide frame pulse (WFP) frame alignment mode.

In ST-BUS/GCI mode, the input 8 kHz frame pulse can be in either ST-BUS or GCI format. The MT90823 automatically detects the presence of an input frame pulse and identifies it as either ST-BUS or GCI. In ST-BUS format, every second falling edge of the master clock marks a bit boundary and the data is clocked in on the rising edge of CLK, three quarters of the way into the bit cell, see Figure 11. In GCI format, every second rising edge of the master clocked in on the falling edge of CLK at three quarters of the way into the bit could be bit cell, see Figure 11. In GCI format, every second rising edge of the master clocked in on the falling edge of CLK at three quarters of the way into the bit cell, see Figure 12.

#### Wide Frame Pulse (WFP) Frame Alignment Timing

When the device is in WFP frame alignment mode, the CLK input must be at 16.384 MHz, the FE/HCLK input is 4.096 MHz and the 8 kHz frame pulse is in ST-BUS format. The timing relationship between CLK, HCLK and the frame pulse is defined in Figure 13.

When the WFPS pin is high, the frame alignment evaluation feature is disabled, but the frame input offset registers may still be programmed to compensate for the varying frame delays on the serial input streams.

## **Switching Configurations**

The MT90823 maximum non-blocking switching configurations is determined by the data rates selected for the serial inputs and outputs. The switching configuration is selected by two DR bits in the IMS register. See Table 8 nd Table 9.

2.048 Mb/s Serial Links (DR0=0, DR1=0)

When the 2.048 Mb/s data rate is selected, the device is configured with 16-input/16-output data streams each having 32 64 kb/s channels. This mode requires a CLK of 4.094 MHz and allows a maximum non-blocking capacity of 512 x 512 channels.

#### 4.096 Mb/s Serial Links (DR0=1, DR1=0)

When the 4.096 Mb/s data rate is selected, the device is configured with 16-input/16-output data streams each having 64 64 kb/s channels. This mode requires a CLK of 8.192 MHz and allows a maximum non-blocking capacity of 1,024 x 1,024 channels.

#### 8.192 Mb/s Serial Links (DR0=0, DR1=1)

When the 8.192 Mb/s data rate is selected, the device is configured with 16-input/16-output data streams each having 128 64 kb/s channels. This mode requires a CLK of 16.384 MHz and allows a maximum non-blocking capacity of 2,048 x 2,048 channels. Table 1 summarizes the switching configurations and the relationship between different serial data rates and the master clock frequencies.

| Serial Interface<br>Data Rate | Master Clock<br>Required (MHz) | Matrix Channel<br>Capacity |  |
|-------------------------------|--------------------------------|----------------------------|--|
| 2 Mb/s                        | 4.096                          | 512 x 512                  |  |
| 4 Mb/s                        | 8.192                          | 1,024 x 1,024              |  |
| 8 Mb/s                        | 16.384                         | 2,048 x 2,048              |  |

Table 1 - Switching Configuration

#### Input Frame Offset Selection

Input frame offset selection allows the channel alignment of individual input streams to be offset with respect to the output stream channel alignment (i.e. F0i). This feature is useful in compensating for variable path delays caused by serial backplanes of variable lengths, which may be implemented in large centralized and distributed switching systems.

Each input stream can have its own delay offset value by programming the frame input offset (FOR) registers. Possible adjustment can range up to +4 master clock (CLK) periods forward with resolution of 1/2 clock period. The output frame offset cannot be offset or adjusted. See Figure 4, Table 11 and Table 12 for delay offset programming.

#### Serial Input Frame Alignment Evaluation

The MT90823 provides the frame evaluation (FE) input to determine different data input delays with respect to the frame pulse F0i.

A measurement cycle is started by setting the start frame evaluation (SFE) bit low for at least one frame. Then the evaluation starts when the SFE bit in the IMS register is changed from low to high. Two frames later, the complete frame evaluation (CFE) bit of the frame alignment register (FAR) changes from low to high. This signals that a valid offset measurement is ready to be read from bits 0 to 11 of the FAR register. The SFE bit must be set to zero before starting a new measurement cycle.

In ST-BUS mode, the falling edge of the frame measurement signal (FE) is evaluated against the falling edge of the ST-BUS frame pulse. In GCI mode, the rising edge of FE is evaluated against the rising edge of the GCI frame pulse. See Table 10 and Figure 3 for the description of the frame alignment register.

This feature is not available when the WFP Frame Alignment mode is enabled (i.e., when the WFPS pin is connected to VDD).

#### Memory Block Programming

The MT90823 provides users with the capability of initializing the entire connection memory block in two frames. Bits 11 to 15 of every connection memory location will be programmed with the pattern stored in bits 5 to 9 of the IMS register.

The block programming mode is enabled by setting the memory block program (MBP) bit of the control register high. When the block programming enable (BPE) bit of the IMS register is set to high, the block programming data will be loaded into the bits 11 to 15 of every connection memory location. The other connection memory bits (bit 0 to bit 10) are loaded with zeros. When the memory block programming is complete, the device resets the BPE bit to zero.

#### Loopback Control

The loopback control (LPBK) bit of each connection memory location allows the ST-BUS output data to be looped backed internally to the ST-BUS input for diagnostic purposes.

If the LPBK bit is high, the associated ST-BUS output channel data is internally looped back to the ST-BUS input channel (i.e., data from STo *n* channel *m* will appear in STi n channel M). **Note:** when LPBK is activated in channel *m* STo n+1 (for *n* even) or STo n-1 (for *n* odd), the data from channel *m* of STi *n* will be switched to channel *m* STo *n*. The associated frame delay offset register must be set to zero for proper operation of the per-channel loopback function. If the LPBK bit is low, the per-channel loopback feature is disabled and the device will function normally.

# **Delay Through the MT90823**

The switching of information from the input serial streams to the output serial streams results in a throughput delay. The device can be programmed to perform time-slot interchange functions with different throughput delay capabilities on a per-channel basis. For voice application, select variable throughput delay to ensure minimum delay between input and output data. In wideband data applications, select constant throughput delay to maintain the frame integrity of the information through the switch.

The delay through the device varies according to the type of throughput delay selected in the  $\overline{V}/C$  bit of the connection memory.

## Variable Delay Mode ( $\overline{V}/C$ bit = 0)

The delay in this mode is dependent only on the combination of source and destination channels. It is independent of input and output streams. The minimum delay achievable in the MT90823 is three time-slots. When the input channel data is switched to the same output channel (channel n, frame p), it will be output in the following frame (channel n, frame p+1). The same frame delay occurs if the input channel n is switched to output channel n+3 m+4,..., the new output data will appear in the same frame. Table 2 shows the possible delays for the MT90823 in the variable delay mode.

## Constant Delay Mode ( $\overline{V}/C$ bit = 1)

In this mode, frame integrity is maintained in all switching configurations by using a multiple data memory buffer. Input channel data written into the data memory buffers during frame n will be read out during frame n+2.

In the MT90823, the minimum throughput delay achievable in the constant delay mode is one frame. For example, in 2 Mb/s mode, when input time-slot 31 is switched to output time-slot 0. The maximum delay of 94 time-slots occurs when time-slot 0 in a frame is switched to time-slot 31 in the frame. See Table 3.

## **Microprocessor Interface**

The MT90823 provides a parallel microprocessor interface for non-multiplexed or multiplexed bus structures. This interface is compatible with Motorola non-multiplexed and multiplexed buses.

If the IM pin is low, the MT90823 microprocessor interface assumes Motorola non-multiplexed bus mode. If the IM pin is high, the device micro- processor interface accepts two different timing modes (mode1 and mode2) which allows direct connection to multiplexed microprocessors.

The microprocessor interface automatically identifies the type of microprocessor bus connected to the MT90823. This circuit uses the level of the DS/RD input pin at the rising edge of AS/ALE to identify the appropriate bus timing connected to the MT90823. If DS/RD is high at the falling edge of AS/ALE, then the mode 1 multiplexed timing is selected. If DS/RD is low at the falling edge of AS/ALE, then the mode 2 multiplexed bus timing is selected.

| Input Rate | Delay for Variable Throughput Delay Mode<br>(m - output channel number)<br>(n - input channel number)) |                     |                |  |  |  |
|------------|--|---------------------|----------------|--|--|--|
|            | m < n  | m = n, n+1, n+2     | m > n+2        |  |  |  |
| 2.048 Mb/s | 32 - (n-m) time-slots  | m-n + 32 time-slots | m-n time-slots |  |  |  |
| 4.096 Mb/s | 64 - (n-m) time-slots  | m-n + 64 time-slots | m-n time-slots |  |  |  |
| 8.192 Mb/s | 128 - (n-m) time-slots     m-n + 128 time-slots     m-n time-slots                                     |                     |                |  |  |  |

#### Table 2 - Variable Throughput Delay Value

| Input Rate | Delay for Constant Throughput Delay Mode<br>(m - output channel number)<br>(n - input channel number)) |
|------------|--|
| 2.048 Mb/s | 32 + (32 - n) + (m - 1) time-slots   |
| 4.096 Mb/s | 64 + (64 - n) + (m- 1) time-slots  |
| 8.192 Mb/s | 128 + (128 - n) + (m- 1) time-slots  |

#### Table 3 - Constant Throughput Delay Value

For multiplexed operation, the 8-bit data and address (AD0-AD7), 8-bit Data (D8-D15), Address strobe/Address latch enable (AS/ALE), Data strobe/Read (DS/RD), Read/Write /Write (R/W / WR), Chip select (CS) and Data transfer acknowledge (DTA) signals are required. See Figure 13 and Figure 14 for multiplexed parallel microport timing.

For the Motorola non-multiplexed bus, the 16-bit data bus (AD0-AD7, D8-D15), 8-bit address bus (A0-A7) and 4 control lines (CS, DS, R/W and DTA) signals are required. See Figure 15 for Motorola non- multiplexed microport timing.

The MT90823 microport provides access to the internal registers, connection and data memories. All locations provide read/write access except for the data memory and the frame alignment register which are read only.

#### **Memory Mapping**

The address bus on the microprocessor interface selects the MT90823 internal registers and memory. If the A7 address input is low, then the control (CR), interface mode selection (IMS), frame alignment (FAR) and frame input offset (FOR) registers are addressed by A6 to A0 as shown in Table 4.

If the A7 address input is high, then the remaining address input lines are used to select up to 128 memory subsection locations. The number selected corresponds to the maximum number of channels per input or output stream. The address input lines and the stream address bits (STA) of the control register allow access to the entire data and connection memories.

The control and IMS registers together control all the major functions of the device. The IMS register should be programmed immediately after system power-up to establish the desired switching configuration (see "Serial Data Interface Timing" and "Switching Configurations").

The control register controls switching operations in the MT90823. It selects the internal memory locations that specify the input and output channels selected for switching.

The data in the control register consists of the memory block programming bit (MBP), the memory select bit (MS) and the stream address bits (STA). The memory block programming bit allows users to program the entire connection memory block, (see "Memory Block Programming"). The memory select bit controls the selection of the connection memory or the data Memory. The stream address bits define an internal memory subsections corresponding to input or output ST-BUS streams.

The data in the IMS register consists of block programming bits (BPD0-BPD4), block programming enable bit (BPE), output standby bit (OSB), start frame evaluation bit (SFE) and data rate selection bits (DR0, DR1). The block programming and the block programming enable bits allows users to program the entire connection memory, (see Memory Block Programming section). If the ODE pin is low, the OSB bit enables (if high) or disables (if low) all ST-BUS output drivers. If the ODE pin is high, the contents of the OSB bit is ignored and all ST-BUS output drivers are enabled.

## **Connection Memory Control**

The contents of the CSTo bit of each connection memory location are output on the CSTo pin once every frame. The CSTo pin is a 4.096, 8.192 or 16.384 Mb/s output carrying 512, 1,024 or 2,048 bits respectively. If the CSTo bit is set high, the corresponding bit on the CSTo output is transmitted high. If the CSTo bit is low, the corresponding bit on the CSTo output is transmitted high. If the CSTo bit is low, the corresponding bit on the CSTo pin and are synchronous with the data rates on the other ST-BUS streams.

The CSTo bit is output one channel before the corresponding channel on the ST-BUS. For example, in 2Mb/s mode, the contents of the CSTo bit in position 0 (STo0, CH0) of the connection memory is output on the first clock cycle of channel 31 via CSTo pin. The contents of the CSTo bit in position 32 (STo1, CH0) of the connection memory is output on the second clock cycle of channel 31 via CSTo pin.

When either the ODE pin or the OSB bit is high, the OE bit of each connection memory location enables (if high) or disables (if low) the output drivers for an individual ST-BUS output stream and channel. Table 5 details this function.

The connection memory message channel (MC) bit (if high) enables message mode in the associated ST-BUS output channel. When message mode is enabled, only the lower half (8 least significant bits) of the connection memory is transferred to the ST-BUS outputs.

If the MC bit is low, the contents of the connection memory stream address bit (SAB) and channel address bit (CAB) defines the source information (stream and channel) of the time-slot that will be switched to the output.

Bit  $\overline{V}/C$  (Variable/Constant Delay) of each connection memory location allows the per-channel selection between variable and constant throughput delay modes.

The loopback bit should be used for diagnostic purpose only; this bit should be set to zero for normal operation. If all LPBK bits are set high for all connection memory locations, the associated ST-BUS output channel data is internally looped back to the ST-BUS input channel (i.e., SToN channel *m* data loops back to STi N channel *m*).

| <b>A7</b><br>(Note 1) | A6          | A5          | A4     | A3     | A2     | A1     | A0     | Location                               |
|-----------------------|-------------|-------------|--------|--------|--------|--------|--------|--|
| 0                     | 0           | 0           | 0      | 0      | 0      | 0      | 0      | Control Register, CR                   |
| 0                     | 0           | 0           | 0      | 0      | 0      | 0      | 1      | Interface Mode Selection Register, IMS |
| 0                     | 0           | 0           | 0      | 0      | 0      | 1      | 0      | Frame Alignment Register, FAR          |
| 0                     | 0           | 0           | 0      | 0      | 0      | 1      | 1      | Frame Input Offset Register 0, FOR0    |
| 0                     | 0           | 0           | 0      | 0      | 1      | 0      | 0      | Frame Input Offset Register 1, FOR1    |
| 0                     | 0           | 0           | 0      | 0      | 1      | 0      | 1      | Frame Input Offset Register 2, FOR2    |
| 0                     | 0           | 0           | 0      | 0      | 1      | 1      | 0      | Frame Input Offset Register 3, FOR3    |
| 1                     | 0<br>0      | 0           | 0<br>0 | 0<br>0 | 0<br>0 | 0<br>0 | 0<br>1 | Ch 0<br>Ch 1                           |
| 1<br>1<br>1           | 0<br>0<br>0 | 0<br>0<br>0 | 1<br>1 | 1<br>1 | 1<br>1 | 1<br>1 | 0<br>1 | Ch 30<br>Ch 31 (Note 2)                |
| 1<br>1<br>1           | 0<br>0<br>0 | 1<br>1<br>1 | 0<br>0 | 0<br>0 | 0<br>0 | 0<br>0 | 0<br>1 | Ch 32<br>Ch 33                         |
| 1<br>1                | 0<br>0      | 1<br>1      | 1<br>1 | 1<br>1 | 1<br>1 | 1<br>1 | 0<br>1 | Ch 62<br>Ch 63 (Note 3)                |
| 1<br>1<br>1           | 1<br>1<br>1 | 0<br>0      | 0<br>0 | 0<br>0 | 0<br>0 | 0<br>0 | 0<br>1 | Ch 64<br>Ch 65                         |
| 1<br>1                | 1<br>1      | 1<br>1      | 1<br>1 | 1<br>1 | 1<br>1 | 1<br>1 | 0<br>1 | Ch 126<br>Ch 127 (Note 4               |

Notes:

Bit A7 must be high for access to data and connection memory positions. Bit A7 must be low for access to registers.
 Channels 0 to 31 are used when serial interface is at 2Mb/s mode.

Channels 0 to 63 are used when serial interface is at 4Mb/s mode.
 Channels 0 to 127 are used when serial interface is at 8Mb/s mode.

**Table 4 - Internal Register and Address Memory Mapping** 

| OE bit in Connection<br>Memory | ODE pin    | OSB bit in IMS register | ST-BUS Output Driver Status   |
|--------------------------------|------------|-------------------------|-------------------------------|
| 0                              | Don't Care | Don't Care              | Per Channel<br>High Impedance |
| 1                              | 0          | 0                       | High Impedance                |
| 1                              | 0          | 1                       | Enable                        |
| 1                              | 1          | Don't care              | Enable                        |

#### Table 5 - Output High Impedance Control

If the LPBK bit is low, the loopback feature is disabled. For proper per-channel loopback operation, the contents of the frame delay offset registers must be set to zero.

## Initialization of the MT90823

During power up, the TRST pin should be pulsed low, or held low continuously, to ensure that the MT90863 is in the normal functional mode. A 5K pull-down resistor can be connected to this pin so that the device will not enter the JTAG test mode during power up.

Upon power up, the contents of the connection memory can be in any state and the ODE pin should be held low to keep all ST-BUS outputs in a high impedance state until the microprocessor has initialized the switching matrix.

To prevent two ST-BUS outputs from driving the same stream simultaneously, the microprocessor should program the desired active paths through the switch and put all other channels into a high impedance state during the initialization routine by using the block programming mode. In addition, the loopback bits in the connection memory should be cleared for normal operation.

When this process is complete, the microprocessor controlling the matrices can bring the ODE pin or OSB bit high to relinquish the high impedance state control to the OE bit in the connection memory.

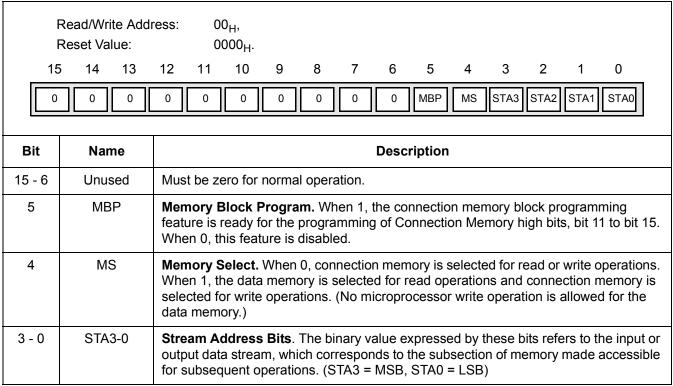


Table 6 - Control (CR) Register Bits

| Input/Output<br>Data Rate | Valid Address Lines       |
|---------------------------|---------------------------|
| 2.048 Mb/s                | A4, A3, A2, A1, A0        |
| 4.096 Mb/s                | A5, A4, A3, A2, A1, A0    |
| 8.192 Mb/s                | A6, A5, A4 A3, A2, A1, A0 |

#### Table 7 - Valid Address lines for Different Bit Rates

|       | Read/Write Add |  |  |  |  |  |  |  |
|-------|----------------|--|--|--|--|--|--|--|
|       | Reset Value:   | 0000 <sub>H</sub> .  |  |  |  |  |  |  |
| 15    | 5 14 13        | 12 11 10 9 8 7 6 5 4 3 2 1 0   |  |  |  |  |  |  |
| 0     | 0 0            | 0 0 0 BPD BPD BPD BPD BPD BPD 0 BPE OSB SFE DR1 DR0  |  |  |  |  |  |  |
| Bit   | Name           | Description  |  |  |  |  |  |  |
| 15-10 | Unused         | Must be zero for normal operation.   |  |  |  |  |  |  |
| 9-5   | BPD4-0         | <b>Block Programming Data.</b> These bits carry the value to be loaded into the connection memory block whenever the memory block programming feature is activated. After the MBP bit in the control register is set to 1 and the BPE bit is set to 1, the contents of the bits BPD4- 0 are loaded into bit 15 to bit 11 of the connection memory. Bit 10 to bit 0 of the connection memory are set to 0.  |  |  |  |  |  |  |
| 4     | BPE            | <b>Begin Block programming Enable.</b> A zero to one transition of this bit enables the memory block programming function. The BPE and BPD4-0 bits in the IMS register have to be defined in the same write operation. Once the BPE bit is set high, the device requires two frames to complete the block programming. After the programming function has finished, the BPE bit returns to zero to indicate the operation is completed. When the BPE = 1, the BPE or MBP can be set to 0 to abort the programming operation. When BPE = 1, the other bits in the IMS register must not be changed for two frames to ensure proper operation. |  |  |  |  |  |  |
| 3     | OSB            | <b>Output standby.</b> When ODE = 0 and OSB = 0, the output drivers of STo0 to STo15 are in high impedance mode. When ODE = 0 and OSB = 1, the output driver of STo0 to STo15 function normally. When ODE = 1, STo0 to STo15 output drivers function normally.   |  |  |  |  |  |  |
| 2     | SFE            | <b>Start Frame Evaluation.</b> A zero to one transition in this bit starts the frame evaluation procedure. When the CFE bit in the FAR register changes from zero to one, the evaluation procedure stops. To start another frame evaluation cycle, set this bit to zero for at least one frame.  |  |  |  |  |  |  |
| 1 - 0 | DR1-0          | <b>Data Rate Select.</b> Input/Output data rate selection. See Table 9 for detailed programming.   |  |  |  |  |  |  |
|       |                | Table 8 - Interface Mode Selection (IMS) Register Bits   |  |  |  |  |  |  |

 Table 8 - Interface Mode Selection (IMS) Register Bits

| DR1 | DR0 | Data Rate Selected | Master Clock Required |  |  |  |
|-----|-----|--------------------|-----------------------|--|--|--|
| 0   | 0   | 2.048 Mb/s         | 4.096 MHz             |  |  |  |
| 0   | 1   | 4.096 Mb/s         | 8.192 MHz             |  |  |  |
| 1   | 0   | 8.192 Mb/s         | 16.384 MHz            |  |  |  |
| 1   | 1   | Reserved           | Reserved              |  |  |  |

## Table 9 - Serial Data Rate Selection (16 input x 16 output)

|         | ead Address:<br>eset Value: | 02 <sub>H</sub> ,<br>0000 <sub>H</sub> .   |  |  |  |  |  |
|---------|-----------------------------|--|--|--|--|--|--|
| 15      |                             |  |  |  |  |  |  |
| 15      | 14 13 12                    | 11 10 9 8 7 6 5 4 3 2 1 0  |  |  |  |  |  |
| 0       | 0 0 CFE                     | FD11 FD10 FD9 FD8 FD7 FD6 FD5 FD4 FD3 FD2 FD1 FD0  |  |  |  |  |  |
|         | 1                           |  |  |  |  |  |  |
| Bit     | Name                        | Description  |  |  |  |  |  |
| 15 - 13 | Unused                      | Must be zero for normal operation.   |  |  |  |  |  |
| 12      | CFE                         | <b>Complete Frame Evaluation.</b> When CFE = 1, the frame evaluation is completed and bits FD10 to FD0 bits contains a valid frame alignment offset. This bit is reset to zero, when SFE bit in the IMS register is changed from 1 to 0. |  |  |  |  |  |
| 11      | FD11                        | <b>Frame Delay Bit 11.</b> The falling edge of FE (or rising edge for GCI mode) is sampled during the CLK-high phase (FD11 = 1) or during the CLK-low phase (FD11 = 0). This bit allows the measurement resolution to 1/2 CLK cycle.     |  |  |  |  |  |
| 10 - 0  | FD10-0                      | <b>Frame Delay Bits.</b> The binary value expressed in these bits refers to the measured input offset value. These bits are reset to zero when the SFE bit of the IMS register changes from 1 to 0. (FD10 = MSB, FD0 = LSB)              |  |  |  |  |  |

Table 10 - Frame Alignment (FAR) Register Bits

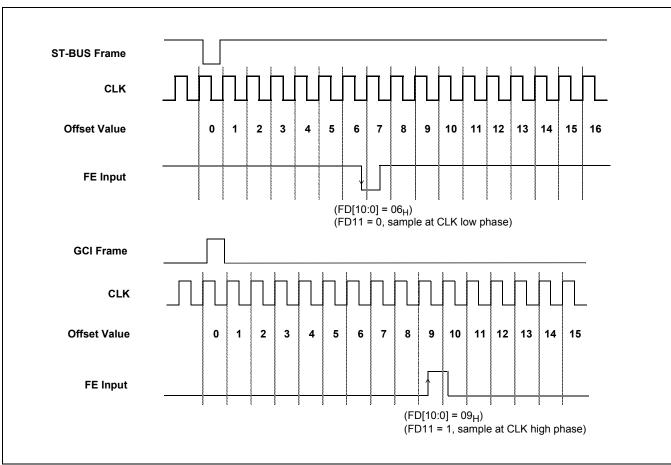


Figure 4 - Example for Frame Alignment Measurement

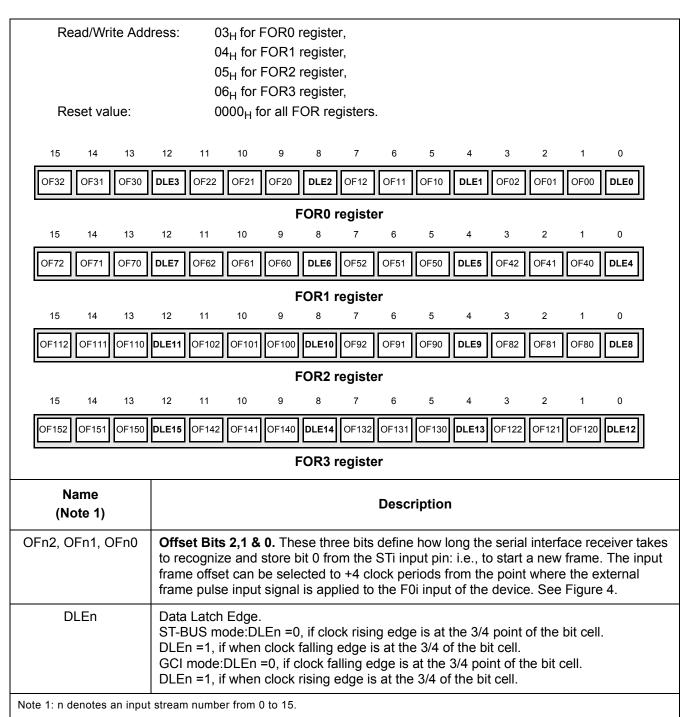


Table 11 - Frame Input Offset (FOR) Register Bits

| Input Stream<br>Offset          |      | urement<br>rame De |     |     | Corresponding<br>Offset Bits |      |      |      |
|---------------------------------|------|--------------------|-----|-----|------------------------------|------|------|------|
| Onser                           | FD11 | FD2                | FD1 | FD0 | OFn2                         | OFn1 | OFn0 | DLEn |
| No clock period shift (Default) | 1    | 0                  | 0   | 0   | 0                            | 0    | 0    | 0    |
| + 0.5 clock period shift        | 0    | 0                  | 0   | 0   | 0                            | 0    | 0    | 1    |
| +1.0 clock period shift         | 1    | 0                  | 0   | 1   | 0                            | 0    | 1    | 0    |
| +1.5 clock period shift         | 0    | 0                  | 0   | 1   | 0                            | 0    | 1    | 1    |
| +2.0 clock period shift         | 1    | 0                  | 1   | 0   | 0                            | 1    | 0    | 0    |
| +2.5 clock period shift         | 0    | 0                  | 1   | 0   | 0                            | 1    | 0    | 1    |
| +3.0 clock period shift         | 1    | 0                  | 1   | 1   | 0                            | 1    | 1    | 0    |
| +3.5 clock period shift         | 0    | 0                  | 1   | 1   | 0                            | 1    | 1    | 1    |
| +4.0 clock period shift         | 1    | 1                  | 0   | 0   | 1                            | 0    | 0    | 0    |
| +4.5 clock period shift         | 0    | 1                  | 0   | 0   | 1                            | 0    | 0    | 1    |

Table 12 - Offset Bits (OFn2, OFn1, OFn0, DLEn) and Frame Delay Bits (FD11, FD2-0)

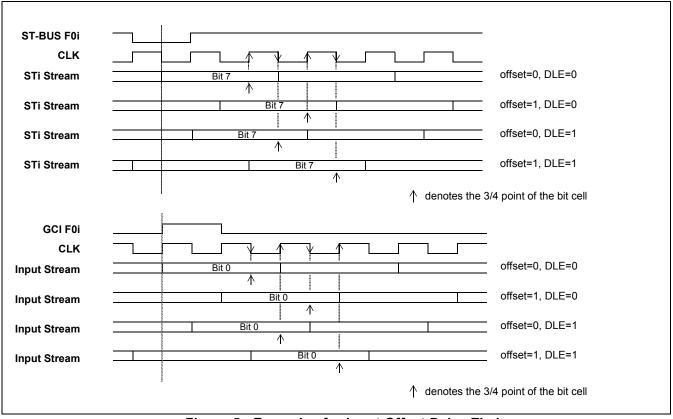


Figure 5 - Examples for Input Offset Delay Timing

| 15<br>LPBK                   | 14 13                            | 12<br>CSTo              | 11 10<br>OE SAB3                  | 9 8<br>SAB2 SAE   | 7<br>31 SAB0           | 6<br>CAB6  | 5<br>CAB5            | 4<br>CAB4          | 3<br>CAB3   | 2<br>CAB2 | 1<br>CAB1 | 0<br>САВ0  |  |  |
|------------------------------|----------------------------------|-------------------------|-----------------------------------|---|------------------------|--|----------------------|--------------------|-------------|-----------|-----------|------------|--|--|
| Bit                          | Nan                              | ne                      | Description                       |   |                        |  |                      |                    |             |           |           |            |  |  |
| 15                           | LPB                              | к                       | Set this<br>memory<br>proper p    | <b>Per Channel Loopback.</b> This bit should be use for diagnostic purpose only.<br>Set this bit to zero for normal operation. When loopback bit is set for all<br>memory location, the STi <i>n</i> channel <i>m</i> data comes from STo <i>n</i> channel <i>m</i> . For<br>proper per channel loopback operations, set the delay offset register bits<br>OFn[2:0] to zero for the streams which are in the loopback mode. |                        |  |                      |                    |             |           |           |            |  |  |
| 14                           | √/C                              |                         |                                   | e <b>/Constan</b><br>able (low) a   |                        |  |                      |                    |             |           |           |            |  |  |
| 13                           | МС                               | 2                       | output o<br>(bit 7 - b<br>the con | <b>Message Channel.</b> When 1, the contents of the connection memory are output on the corresponding output channel and stream. Only the lower byte (bit 7 - bit 0) will be output to the ST-BUS output pins. When 0, the contents of the connection memory are the data memory address of the switched input channel and stream.  |                        |  |                      |                    |             |           |           |            |  |  |
| 12                           | CST                              | Го                      |                                   | I <b>ST-BUS o</b><br>ne CSTo bit  |                        |  |                      |                    | ne CS       | To pin o  | one ch    | annel      |  |  |
| 11                           | OE                               |                         | 11 OE                             |   | basis.<br>When 1       | <b>Enable.</b> Th<br>, the output<br>pedance sta | driver fur           |                    |             |           |           |            |  |  |
| 10 - 8,<br>7<br>(Note 1)     | SAB                              | 3-0                     |                                   | Source Stream Address Bits. The binary value is the number of the data stream for the source of the connection.   |                        |  |                      |                    |             |           |           |            |  |  |
| 6 - 0<br>(Note 1)            | CAB                              | 6-0                     |                                   | Channel A<br>for the sou  |                        |  |                      | ary val            | ue is t     | he nun    | nber of   | the        |  |  |
| Note 1: If bit<br>(SAB0, CAB | t 13 (MC) of th<br>6 - CAB0) are | e correspo<br>output on | onding conne<br>the output c      |   | location is ream assoc | 1 (devi<br>ciated w                              | ce in m<br>rith this | essage<br>locatior | mode)<br>1. | , then th | iese ent  | ire 8 bits |  |  |

# Table 13 - Connection Memory Bits

| Data Rate  | CAB Bits Used to Determine the Source Channel of the Connection |
|------------|---|
| 2.048 Mb/s | CAB4 to CAB0 (32 channel/input stream)                          |
| 4.096 Mb/s | CAB5 to CAB0 (64 channel/input stream)                          |
| 8.192 Mb/s | CAB6 to CAB0 (128 channel/input stream)                         |

# Table 14 - CAB Bits Programming for Different Data Rates

# JTAG Support

The MT90823 JTAG interface conforms to the IEEE 1149.1 Boundary-Scan standard and the Boundary-Scan Test (BST) design-for-testability technique it specifies. The operation of the boundary-scan circuitry is controlled by an external test access port (TAP) Controller.

## **Test Access Port (TAP)**

The Test Access Port (TAP) provides access to the many test functions of the MT90823. It consists of three input pins and one output pin. The following pins comprise the TAP.

#### • Test Clock Input (TCK)

TCK provides the clock for the test logic. The TCK does not interfere with any on-chip clock and thus remains independent. The TCK permits shifting of test data into or out of the Boundary-Scan register cells concurrently with the operation of the device and without interfering with the on-chip logic.

#### • Test Mode Select Input (TMS)

The logic signals received at the TMS input are interpreted by the TAP Controller to control the test operations. The TMS signals are sampled at the rising edge of the TCK pulse. This pin is internally pulled to Vdd when it is not driven from an external source.

#### • Test Data Input (TDI)

Serial input data applied to this port is fed either into the instruction register or into a test data register, depending on the sequence previously applied to the TMS input. Both registers are described in a subsequent section. The received input data is sampled at the rising edge of TCK pulses. This pin is internally pulled to Vdd when it is not driven from an external source.

#### • Test Data Output (TDO)

Depending on the sequence previously applied to the TMS input, the contents of either the instruction register or data register are serially shifted out towards the TDO. The data out of the TDO is clocked on the falling edge of the TCK pulses. When no data is shifted through the boundary scan cells, the TDO driver is set to a high impedance state.

#### Test Reset (TRST)

Resets the JTAG scan structure. This pin is internally pulled to VDD.

#### Instruction Register

In accordance with the IEEE 1149.1 standard, the MT90823 uses public instructions. The MT90823 JTAG Interface contains a three-bit instruction register. Instructions are serially loaded into the instruction register from the TDI when the TAP Controller is in its shifted-IR state. Subsequently, the instructions are decoded to achieve two basic functions: to select the test data register that may operate while the instruction is current, and to define the serial test data register path, which is used to shift data between TDI and TDO during data register scanning.

#### **Test Data Register**

As specified in IEEE 1149.1, the MT90823 JTAG Interface contains three test data registers:

The Boundary-Scan Register
 The Boundary-Scan register consists of a series of Boundary-Scan cells arranged to form a scan path
 around the boundary of the MT90823 core logic.

# The Bypass Register

The Bypass register is a single stage shift register that provides a one-bit path from TDI to its TDO.

• **The Device Identification Register** The device identification register is a 32-bit register with the register contain of:

MSB 2000 0000 1000 0010 0011 0001 0100 1011

The LSB bit in the device identification register is the first bit clocked out.

The MT90823 boundary scan register contains 118 bits. Bit 0 in Table 15 Boundary Scan Register is the first bit clocked out. All tristate enable bits are active high.

|            | Boundary            | to Bit 117             |                       |
|------------|---------------------|------------------------|-----------------------|
| Device Pin | Tristate<br>Control | Output<br>Scan<br>Cell | Input<br>Scan<br>Cell |
| STo7       | 0                   | 1                      |                       |
| STo6       | 2                   | 3                      |                       |
| STo5       | 4                   | 5                      |                       |
| STo4       | 6                   | 7                      |                       |
| STo3       | 8                   | 9                      |                       |
| STo2       | 10                  | 11                     |                       |
| STo1       | 12                  | 13                     |                       |
| STo0       | 14                  | 15                     |                       |
| ODE        |                     |                        | 16                    |
| CSTo       | 17                  | 18                     |                       |
| DTA        |                     | 19                     |                       |
| D15        | 20                  | 21                     | 22                    |
| D14        | 23                  | 24                     | 25                    |
| D13        | 26                  | 27                     | 28                    |
| D12        | 29                  | 30                     | 31                    |
| D11        | 32                  | 33                     | 34                    |
| D10        | 35                  | 36                     | 37                    |
| D9         | 38                  | 39                     | 40                    |
| D8         | 41                  | 42                     | 43                    |
| AD7        | 44                  | 45                     | 46                    |
| AD6        | 47                  | 48                     | 49                    |
| AD5        | 50                  | 51                     | 52                    |
| AD4        | 53                  | 54                     | 55                    |
| AD3        | 56                  | 57                     | 58                    |
| AD2        | 59                  | 60                     | 61                    |
| AD1        | 62                  | 63                     | 64                    |
| AD0        | 65                  | 66                     | 67                    |
| IM         |                     |                        | 68                    |
| AS/ALE     |                     |                        | 69                    |
| CS         |                     |                        | 70                    |
| R/W / WR   |                     |                        | 71                    |
| DS/RD      |                     |                        | 72                    |

Table 14 - Boundary Scan Register Bits

|              | Boundary            | / Scan Bit 0           | to Bit 117            |
|--------------|---------------------|------------------------|-----------------------|
| Device Pin   | Tristate<br>Control | Output<br>Scan<br>Cell | Input<br>Scan<br>Cell |
| A7           |                     |                        | 73                    |
| A6           |                     |                        | 74                    |
| A5           |                     |                        | 75                    |
| A4           |                     |                        | 76                    |
| A3           |                     |                        | 77                    |
| A2           |                     |                        | 78                    |
| A1           |                     |                        | 79                    |
| A0           |                     |                        | 80                    |
| WFPS         |                     |                        | 81                    |
| RESET        |                     |                        | 82                    |
| CLK          |                     |                        | 83                    |
| FE/HCLK      |                     |                        | 84                    |
| F0i          |                     |                        | 85                    |
| STi15        |                     |                        | 86                    |
| STi14        |                     |                        | 87                    |
| STi13        |                     |                        | 88                    |
| STi12        |                     |                        | 89                    |
| STi11        |                     |                        | 90                    |
| STi10        |                     |                        | 91                    |
| STi9         |                     |                        | 92                    |
| STi8         |                     |                        | 93                    |
| STi7         |                     |                        | 94                    |
| STi6         |                     |                        | 95                    |
| STi5         |                     |                        | 96<br>07              |
| STi4         |                     |                        | 97<br>08              |
| STi3<br>STi2 |                     |                        | 98<br>99              |
| STI2<br>STi1 |                     |                        | 99<br>100             |
| STi0         |                     |                        | 100                   |
| STo15        | 102                 | 103                    | -                     |
| STo14        | 104                 | 105                    |                       |
| STo13        | 106                 | 107                    |                       |
| STo12        | 108                 | 109                    |                       |
| STo11        | 110                 | 111                    |                       |
| STo10        | 112                 | 113                    |                       |
| STo9         | 114                 | 115                    |                       |
| STo8         | 116                 | 117                    |                       |

Table 14 - Boundary Scan Register Bits (continued)

# Applications

## **Switch Matrix Architectures**

The MT90823 is an ideal device for medium to large size switch matrices where voice and grouped data channels are transported within the same frame. In such applications, the voice samples have to be time interchanged with a minimum delay while maintain- ing the integrity of grouped data. To ensure the integrity of grouped data during switching and to provide a minimum delay for voice connections, the MT90823 provides per-channel selection between variable and constant throughput delay. This can be selected by the  $\overline{V}/C$  bit of the Connection Memory. Figure 6 illustrates how four MT90823 devices can be used to form non-blocking switches for up to 4096 channels with data rate of 8.192 Mb/s.

## Serial Input Frame Alignment Evaluation

The MT90823 is capable of performing frame alignment evaluation. The frame pulse under evaluation is connected to the FE (frame measure- ment) pin. An external multiplexer is required to select one of the frame pulses related to the different input streams. Figure 7 - The block diagram at Figure 7 shows a switch matrix that performs frame alignment evaluation for 16 frame pulses.

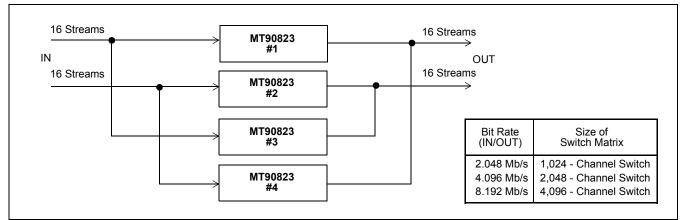
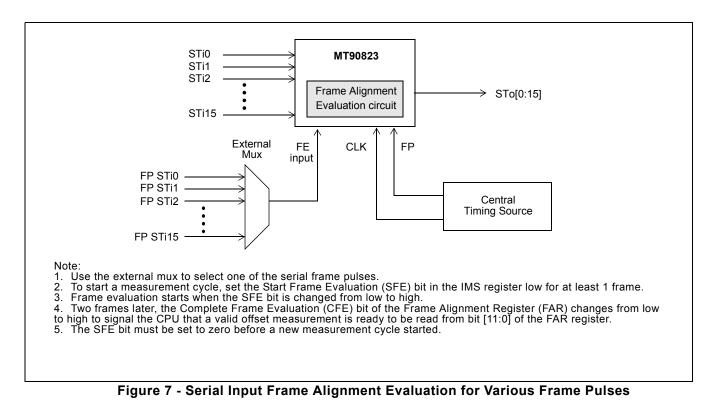


Figure 6 - Switch Matrix with Serial Stream at Various Bit Rates



#### Wide Frame Pulse (WFP) Frame Alignment Mode

When the device is in the wide frame pulse mode and if the input data streams are sampled at 3/4 bit time, the device can operate in the HMVIP and MVIP-90 environment. When input data streams are sampled at half-bit time as specified in the HMVIP and MVIP-90 standard, the device can only operate with data rate of 2 Mb/s. Refer to the ST-BUS output delay parameter, t<sub>SOD</sub>, as specified in the AC Electrical Characteristic table.

The MT90823 is designed to accept a common frame pulse F0i, the 4.096 MHz and 16.384 MHz clocks required by the HMVIP standards. To enable the Wide Frame Pulse Frame Alignment Mode, the WFPS pin has to be set to HIGH and the DR1 and DR0 bits set for 8.192Mb/s data rate operation.

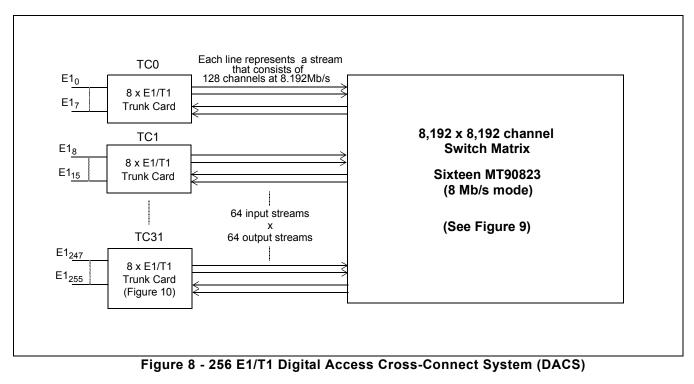
#### **Digital Access Cross-Connect System**

Figure 8 illustrates the use of MT90823 devices to construct a 256 E1/T1 Digital Access Cross- connect System (DACS). The system consists of 32 trunk cards each having eight E1 or T1 trunk interfaces for a total of 256 trunks. Each trunk card uses two MT8986 Multi-rate Digital Switches. The central switching block uses 16 MT90823 devices.

The block diagram at Figure 9 shows how an  $8,192 \times 8,192$  channel switch can be constructed from  $4,096 \times 4,096$  channel switch modules. Figure 6 shows the implementation of the individual  $4,096 \times 4,096$  channel switch modules from four MT90823 devices.

Figure 10 shows an eight-stream trunk card using MT8986 Multi-rate Digital Switches to concentrate 32-channel 2.048 Mb/s ST-BUS (DSTi and DSTo) streams at each E1/T1 trunk onto four 128-channel 8.192 Mb/s streams.

The DACS switching matrix that formerly required 256 MT8986 devices in a square (16 x 16) configuration can now be provided by 64 MT8986 and 16 MT90823 devices (see Figure 8).



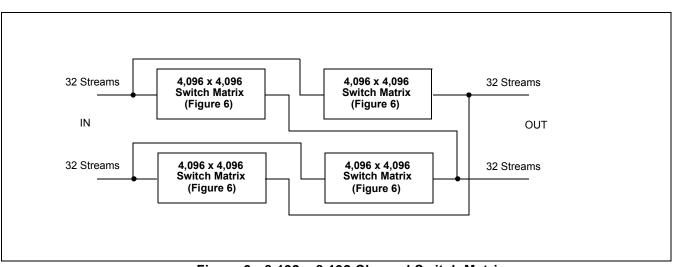


Figure 9 - 8,192 x 8,192 Channel Switch Matrix

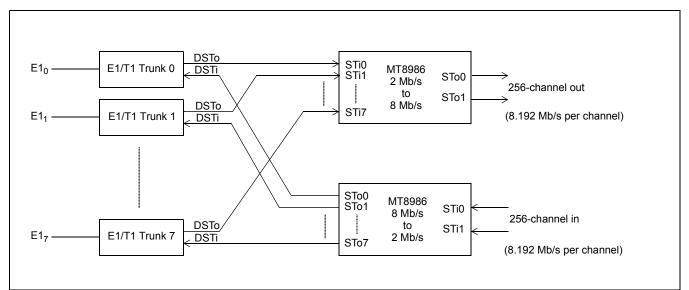


Figure 10 - Trunk Card Block Diagram

## **Absolute Maximum Ratings\***

|   | Parameter   | Sym             | Min                   | Мах                   | Units |
|---|---|-----------------|-----------------------|-----------------------|-------|
| 1 | Supply Voltage  | V <sub>DD</sub> | -0.3                  | 5.0                   | V     |
| 2 | Voltage on any 3.3V Tolerant pin I/O (other than supply pins) | VI              | V <sub>SS</sub> - 0.3 | V <sub>DD</sub> + 0.3 | V     |
| 3 | Voltage on any 5V Tolerant pin I/O (other than supply pins)   | VI              | V <sub>SS</sub> - 0.3 | 5.5                   | V     |
| 4 | Continuous Current at digital outputs                         | Ι <sub>ο</sub>  |                       | 20                    | mA    |
| 5 | Package power dissipation (PLCC & PQFP)                       | PD              |                       | 1                     | W     |
| 6 | Storage temperature   | Τ <sub>S</sub>  | - 65                  | +125                  | °C    |

\* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied

# Recommended Operating Conditions - Voltages are with respect to ground (V<sub>ss</sub>) unless otherwise stated.

|   | Characteristics                             | Sym             | Min         | Тур | Max                | Units | Test Conditions    |
|---|---|-----------------|-------------|-----|--------------------|-------|--------------------|
| 1 | Operating Temperature                       | T <sub>OP</sub> | -40         |     | +85                | °C    |                    |
| 2 | Positive Supply                             | V <sub>DD</sub> | 3.0         |     | 3.6                | V     |                    |
| 3 | Input High Voltage                          | V <sub>IH</sub> | $0.7V_{DD}$ |     | V <sub>DD</sub>    | V     | 400mV noise margin |
| 4 | Input High Voltage on 5V Tolerant<br>Inputs | V <sub>IH</sub> |             |     | 5.5                | V     |                    |
| 5 | Input Low Voltage                           | $V_{IL}$        | $V_{SS}$    |     | $0.3V_{\text{DD}}$ | V     | 400mV noise margin |

|   |             | Charac  | teristics | Sym                                | Min         | Тур | Max                | Units    | Test Conditions                         |
|---|-------------|---|-----------|------------------------------------|-------------|-----|--------------------|----------|---|
| 1 |             |   | @ 2 Mb/s  |                                    |             | 12  | 15                 | mA       |   |
|   |             | Supply Current  | @ 4 Mb/s  | I <sub>DD</sub>                    |             | 20  | 26                 | mA       | Output unloaded                         |
|   |             |   | @ 8 Mb/s  |                                    |             | 45  | 70                 | mA       |   |
| 2 | N<br>P      | Input High Voltag   | je        | $V_{H}$                            | $0.7V_{DD}$ |     |                    | V        |   |
| 3 | U           | Input Low Voltage   |           | $V_{IL}$                           |             |     | 0.3V <sub>DD</sub> | V        |   |
| 4 | S           | Input Leakage (input pins)<br>Input Leakage (with pull-up or pull-<br>down) |           | I <sub>IL</sub><br>I <sub>BL</sub> |             |     | 15<br>50           | μΑ<br>μΑ | 0≤ <v≤v<sub>DD See<br/>Note 1</v≤v<sub> |
| 5 |             | Input Pin Capacit   | tance     | CI                                 |             |     | 10                 | pF       |   |
| 6 | 0           | Output High Volta   | age       | V <sub>OH</sub>                    | $0.8V_{DD}$ |     |                    | V        | I <sub>OH</sub> = -10mA                 |
| 7 | U<br>T      | Output Low Volta  | ige       | V <sub>OL</sub>                    |             |     | 0.4                | V        | I <sub>OL</sub> = 10mA                  |
| 8 | P<br>U<br>T | High Impedance Leakage  |           | I <sub>OZ</sub>                    |             |     | 5                  | μA       | 0 < V < V <sub>DD</sub> See<br>Note 1   |
| 9 | S           | Output Pin Capa   | citance   | CO                                 |             |     | 10                 | pF       |   |

# DC Electrical Characteristics - Voltages are with respect to ground (V<sub>ss</sub>) unless otherwise stated.

Note:

1. Maximum leakage on pins (output or I/O pins in high impedance state) is over an applied voltage (V)

# AC Electrical Characteristics - Timing Parameter Measurement Voltage Levels

|   | Characteristics                  | Sym             | Level              | Units | Conditions |
|---|----------------------------------|-----------------|--------------------|-------|------------|
| 1 | CMOS Threshold                   | V <sub>CT</sub> | $0.5V_{DD}$        | V     |            |
| 2 | Rise/Fall Threshold Voltage High | V <sub>HM</sub> | 0.7V <sub>DD</sub> | V     |            |
| 3 | Rise/Fall Threshold Voltage Low  | $V_{LM}$        | 0.3V <sub>DD</sub> | V     |            |

# **AC Electrical Characteristics - Frame Pulse and CLK**

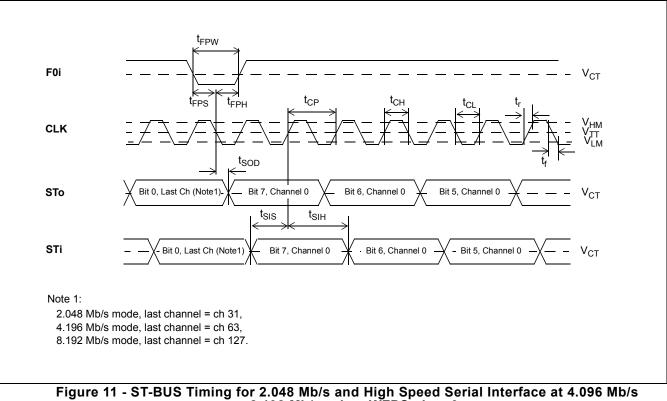
|    | Characteristic   | Sym                               | Min              | Тур | Мах              | Units          | Notes             |
|----|--|-----------------------------------|------------------|-----|------------------|----------------|-------------------|
| 1  | Frame pulse width (ST-BUS, GCI)<br>Bit rate = 2.048 Mb/s<br>Bit rate = 4.096 Mb/s<br>Bit rate = 8.192 Mb/s | t <sub>FPW</sub>                  | 26<br>26<br>26   |     | 295<br>145<br>80 | ns<br>ns<br>ns | WFPS Pin = 0      |
| 2  | Frame Pulse Setup time before<br>CLK falling (ST-BUS or GCI)   | t <sub>FPS</sub>                  | 5                |     |                  | ns             | WFPS Pin = 0      |
| 3  | Frame Pulse Hold Time from CLK falling (ST-BUS or GCI)   | t <sub>FPH</sub>                  | 10               |     |                  | ns             | WFPS Pin = 0      |
| 4  | CLK Period<br>Bit rate = 2.048 Mb/s<br>Bit rate = 4.096 Mb/s<br>Bit rate = 8.192 Mb/s                      | t <sub>CP</sub>                   | 190<br>110<br>55 |     | 300<br>150<br>70 | ns<br>ns<br>ns | WFPS Pin = 0      |
| 5  | CLK Pulse Width High<br>Bit rate = 2.048 Mb/s<br>Bit rate = 4.096 Mb/s<br>Bit rate = 8.192 Mb/s            | t <sub>СН</sub>                   | 85<br>50<br>20   |     | 150<br>75<br>40  | ns<br>ns<br>ns | WFPS Pin = 0      |
| 6  | CLK Pulse Width Low<br>Bit rate = 2.048 Mb/s<br>Bit rate = 4.096 Mb/s<br>Bit rate = 8.192 Mb/s             | t <sub>CL</sub>                   | 85<br>50<br>20   |     | 150<br>75<br>40  | ns<br>ns<br>ns | WFPS Pin = 0      |
| 7  | Clock Rise/Fall Time   | t <sub>r</sub> , t <sub>f</sub>   |                  |     | 10               | ns             |                   |
| 8  | Wide frame pulse width<br>Bit rate = 8.192 Mb/s  | t <sub>HFPW</sub>                 | 195              |     | 295              | ns             | WFPS Pin = 1      |
| 9  | Frame Pulse Setup Time before<br>HCLK falling  | t <sub>HFPS</sub>                 | 5                |     | 150              | ns             | WFPS Pin = 1      |
| 10 | Frame Pulse Hold Time from<br>HCLK falling   | t <sub>HFPH</sub>                 | 10               |     | 150              | ns             | WFPS Pin = 1      |
| 11 | HCLK (4.096MHz) Period<br>Bit rate = 8.192 Mb/s  | t <sub>HCP</sub>                  | 190              |     | 300              | ns             | WFPS Pin = 1      |
| 12 | HCLK (4.096MHz) Pulse Width<br>High<br>Bit rate = 8.192 Mb/s   | t <sub>HCH</sub>                  | 85               |     | 150              | ns             | WFPS Pin = 1      |
| 13 | HCLK (4.096MHz) Pulse Width<br>Low<br>Bit rate = 8.192 Mb/s  | t <sub>HCL</sub>                  | 85               |     | 150              | ns             | WFPS Pin = 1      |
| 14 | HCLK Rise/Fall Time  | t <sub>Hr</sub> , t <sub>Hf</sub> |                  |     | 10               | ns             |                   |
| 15 | Delay between falling edge of<br>HCLK and falling edge of CLK  | t <sub>DIF</sub>                  | -10              |     | 10               | ns             | WFPS Pin = 0 or 1 |

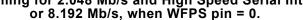
# AC Electrical Characteristics - Serial Streams for ST-BUS and GCI Backplanes

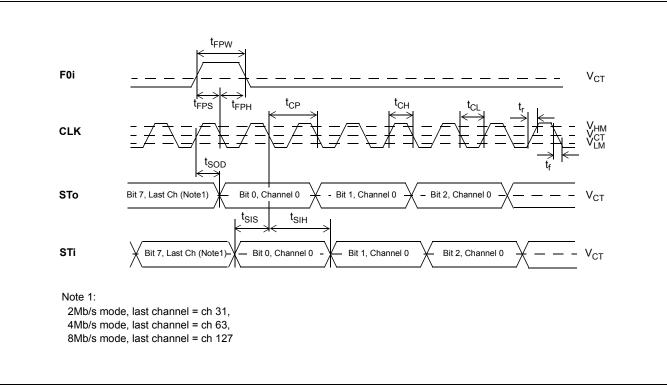
|   | Characteristic                      | Sym              | Min | Тур | Max      | Units    | Test Conditions                                       |
|---|-------------------------------------|------------------|-----|-----|----------|----------|---|
| 1 | Sti Set-up Time                     | t <sub>sis</sub> | 0   |     |          | ns       |   |
| 2 | Sti Hold Time                       | t <sub>SIH</sub> | 10  |     |          | ns       |   |
| 3 | Sto Delay - Active to Active        | t <sub>SOD</sub> |     |     | 30<br>40 | ns<br>ns | C <sub>L</sub> =30pF<br>C <sub>L</sub> =200pF         |
| 4 | STo delay - Active to High-Z        | t <sub>DZ</sub>  |     |     | 32       |          | R <sub>L</sub> =1K, C <sub>L</sub> =200pF, See Note 1 |
| 5 | Sto delay - High-Z to Active        | t <sub>ZD</sub>  |     |     | 32       |          | R <sub>L</sub> =1K, C <sub>L</sub> =200pF, See Note 1 |
| 6 | Output Driver Enable (ODE)<br>Delay | t <sub>ODE</sub> |     |     | 32       | ns       | R <sub>L</sub> =1K, C <sub>L</sub> =200pF, See Note 1 |
| 7 | CSTo Output Delay                   | t <sub>XCD</sub> |     |     | 30<br>40 | ns<br>ns | C <sub>L</sub> =30pF<br>C <sub>L</sub> =200pF         |

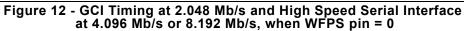
Note:

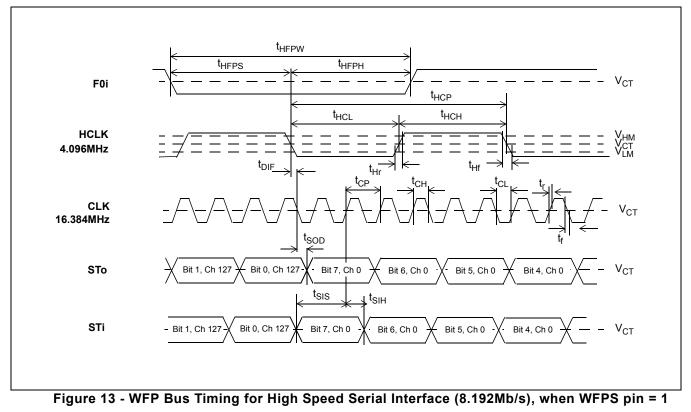
1. High Impedance is measured by pulling to the appropriate rail with R<sub>L</sub>, with timing corrected to cancel time taken to discharge C<sub>L</sub>.





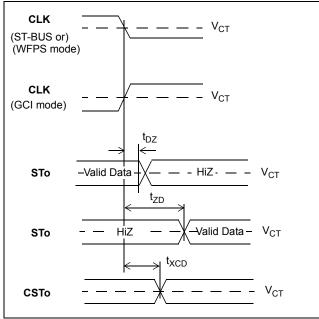


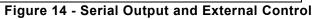




Note:

1. High Impedance is measured by pulling to the appropriate rail with R<sub>L</sub>, with timing corrected to cancel time taken to discharge C<sub>L</sub>.





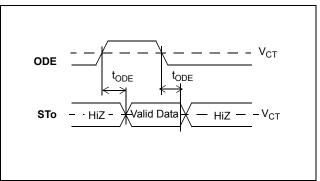


Figure 15 - Output Driver Enable (ODE)

|    | Characteristics  | Sym               | Min | Тур | Max                                    | Units                | Test Conditions  |
|----|--|-------------------|-----|-----|--|----------------------|--|
| 1  | ALE pulse width  | t <sub>ALW</sub>  | 20  |     |  | ns                   |  |
| 2  | Address setup from ALE falling   | t <sub>ADS</sub>  | 3   |     |  | ns                   |  |
| 3  | Address hold from ALE falling  | t <sub>ADH</sub>  | 3   |     |  | ns                   |  |
| 4  | RD active after ALE falling  | t <sub>ALRD</sub> | 3   |     |  | ns                   |  |
| 5  | Data setup from DTA Low on Read  | t <sub>DDR</sub>  | 5   |     |  | ns                   | C <sub>L</sub> =150pF  |
| 6  | CS hold after RD/WR  | t <sub>CSRW</sub> | 5   |     |  | ns                   |  |
| 7  | RD pulse width (fast read)   | t <sub>RW</sub>   | 45  |     |  | ns                   |  |
| 8  | CS setup from RD   | t <sub>CSR</sub>  | 0   |     |  | ns                   |  |
| 9  | Data hold after RD   | t <sub>DHR</sub>  | 10  |     | 20                                     | ns                   | C <sub>L</sub> =150pF, R <sub>L</sub> =1K,<br>Note 1.  |
| 10 | WR pulse width (fast write)  | t <sub>WW</sub>   | 45  |     |  | ns                   |  |
| 11 | WR delay after ALE falling   | t <sub>ALWR</sub> | 3   |     |  | ns                   |  |
| 12 | CS setup from WR   | t <sub>CSW</sub>  | 0   |     |  | ns                   |  |
| 13 | Data setup from WR (fast write)  | t <sub>DSW</sub>  | 20  |     |  | ns                   |  |
| 14 | Valid Data Delay on write (slow write)   | t <sub>SWD</sub>  |     |     | 122                                    | ns                   |  |
| 15 | Data hold after WR inactive  | t <sub>DHW</sub>  | 5   |     |  | ns                   |  |
| 16 | Acknowledgment Delay:<br>Reading/Writing Registers<br>Reading/Writing Memory @ 2Mb/s<br>@ 4Mb/s<br>@ 8Mb/s | t <sub>AKD</sub>  |     |     | 43/43<br>760/750<br>400/390<br>220/210 | ns<br>ns<br>ns<br>ns | C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF |
| 17 | Acknowledgment Hold Time   | t <sub>AKH</sub>  |     |     | 22                                     | ns                   | C <sub>L</sub> =150pF, R <sub>L</sub> =1K,<br>Note 1.  |

# AC Electrical Characteristics - Multiplexed Bus Timing (Mode 1)

Note:

1. High Impedance is measured by pulling to the appropriate rail with R<sub>L</sub>, with timing corrected to cancel time taken to discharge C<sub>L</sub>.

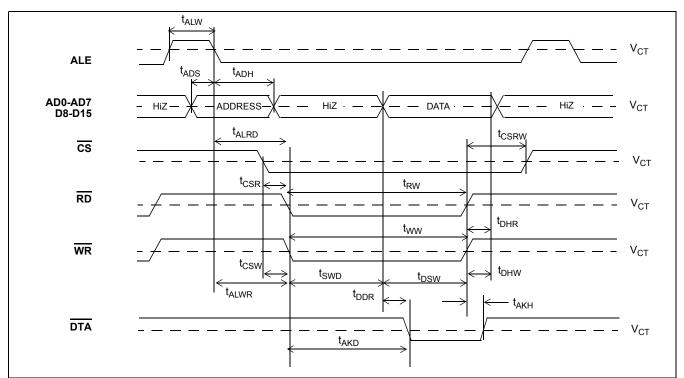


Figure 16 - Multiplexed Bus Timing (Mode 1)

36

|    | Characteristics  | Sym              | Min | Тур | Мах                                    | Units                | Test Conditions  |
|----|--|------------------|-----|-----|--|----------------------|--|
| 1  | AS pulse width   | t <sub>ASW</sub> | 20  |     |  | ns                   |  |
| 2  | Address setup from AS falling  | t <sub>ADS</sub> | 3   |     |  | ns                   |  |
| 3  | Address hold from AS falling   | t <sub>ADH</sub> | 3   |     |  | ns                   |  |
| 4  | Data setup from DTA Low on Read  | t <sub>DDR</sub> | 5   |     |  | ns                   | C <sub>L</sub> =150pF  |
| 5  | CS hold after DS falling   | t <sub>CSH</sub> | 0   |     |  | ns                   |  |
| 6  | CS setup from DS rising  | t <sub>CSS</sub> | 0   |     |  | ns                   |  |
| 7  | Data hold after write  | t <sub>DHW</sub> | 5   |     |  | ns                   |  |
| 8  | Data setup from DS -Write (fast write)   | t <sub>DWS</sub> | 20  |     |  | ns                   |  |
| 9  | Valid Data Delay on write (slow write)   | t <sub>SWD</sub> |     |     | 122                                    | ns                   |  |
| 10 | $R/\overline{W}$ setup from DS rising  | t <sub>RWS</sub> | 60  |     |  | ns                   |  |
| 11 | $R/\overline{W}$ hold after DS falling   | t <sub>RWH</sub> | 5   |     |  | ns                   |  |
| 12 | Data hold after read   | t <sub>DHR</sub> | 10  |     | 20                                     | ns                   | C <sub>L</sub> =150pF, R <sub>L</sub> =1K,<br>Note 1   |
| 13 | DS delay after AS falling  | t <sub>DSH</sub> | 10  |     |  | ns                   |  |
| 14 | Acknowledgment Delay:<br>Reading/Writing Registers<br>Reading/Writing Memory @ 2Mb/s<br>@ 4Mb/s<br>@ 8Mb/s | t <sub>AKD</sub> |     |     | 43/43<br>760/750<br>400/390<br>220/210 | ns<br>ns<br>ns<br>ns | C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF |
| 15 | Acknowledgment Hold Time   | t <sub>AKH</sub> |     |     | 22                                     | ns                   | C <sub>L</sub> =150pF, R <sub>L</sub> =1K,<br>Note 1   |

# AC Electrical Characteristics - Multiplexed Bus Timing (Mode 2)

Note 1. High Impedance is measured by pulling to the appropriate rail with R<sub>L</sub>, with timing corrected to cancel time taken to discharge C<sub>L</sub>.

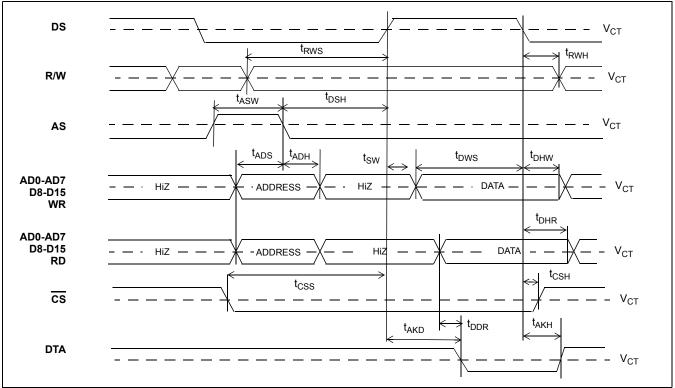


Figure 17 - Multiplexed Bus Timing (Mode2)

# AC Electrical Characteristics - Motorola Non-Multiplexed Bus Mode

|    | Characteristics  | Sym              | Min | Тур | Max                                    | Units                | Test Conditions  |
|----|--|------------------|-----|-----|--|----------------------|--|
| 1  | CS setup from DS falling   | t <sub>CSS</sub> | 0   |     |  | ns                   |  |
| 2  | R/W setup from DS falling  | t <sub>RWS</sub> | 10  |     |  | ns                   |  |
| 3  | Address setup from DS falling  | t <sub>ADS</sub> | 2   |     |  | ns                   |  |
| 4  | CS hold after DS rising  | t <sub>CSH</sub> | 0   |     |  | ns                   |  |
| 5  | $R/\overline{W}$ hold after DS rising  | t <sub>RWH</sub> | 2   |     |  | ns                   |  |
| 6  | Address hold after DS rising   | t <sub>ADH</sub> | 2   |     |  | ns                   |  |
| 7  | Data setup from DTA Low on Read  | t <sub>DDR</sub> | 2   |     |  | ns                   | C <sub>L</sub> =150pF  |
| 8  | Data hold on read  | t <sub>DHR</sub> | 10  |     | 20                                     | ns                   | C <sub>L</sub> =150pF, R <sub>L</sub> =1K<br>Note 1  |
| 9  | Data setup on write (fast write)   | t <sub>DSW</sub> | 0   |     |  | ns                   |  |
| 10 | Valid Data Delay on write (slow write)   | t <sub>SWD</sub> |     |     | 122                                    | ns                   |  |
| 11 | Data hold on write   | t <sub>DHW</sub> | 5   |     |  | ns                   |  |
| 12 | Acknowledgment Delay:<br>Reading/Writing Registers<br>Reading/Writing Memory @ 2Mb/s<br>@ 4Mb/s<br>@ 8Mb/s | t <sub>AKD</sub> |     |     | 43/43<br>760/750<br>400/390<br>220/210 | ns<br>ns<br>ns<br>ns | C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF<br>C <sub>L</sub> =150pF |
| 13 | Acknowledgment Hold Time   | t <sub>AKH</sub> |     |     | 22                                     | ns                   | C <sub>L</sub> =150pF, R <sub>L</sub> =1K,<br>Note 1   |

Note:

38

1. High Impedance is measured by pulling to the appropriate rail with  $R_L$ , with timing corrected to cancel time taken to discharge  $C_L$ .

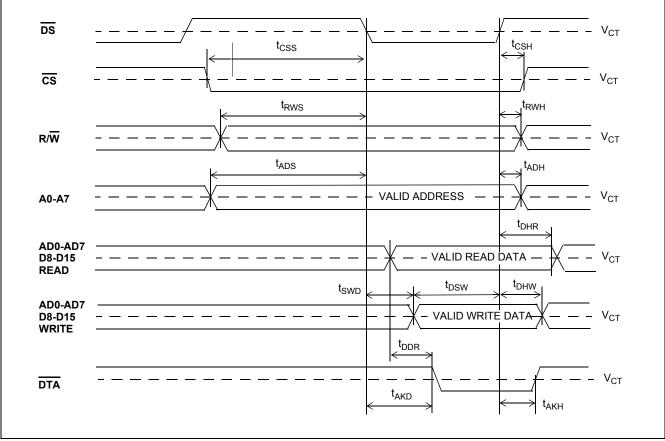
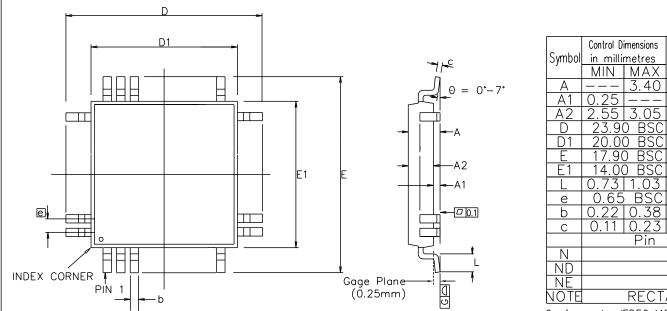


Figure 18 - Motorola Non-Multiplexed Bus Timing



|   | 1.4     |    |    |       | 100    |      |      |   |
|---|---------|----|----|-------|--------|------|------|---|
|   | ND      |    |    |       | 30     |      |      |   |
|   | NE      |    |    |       | 20     |      |      |   |
|   | NOTE    |    |    | REC   | CTANGI | JLAR |      |   |
| ( | Conforn | ns | to | JEDEC | MO-112 | CC-1 | lss. | В |

Pin f<u>eatures</u>

100

3.40

Altern. Dimensions

MIN MAX

0.004 0.009

0.134

in inches

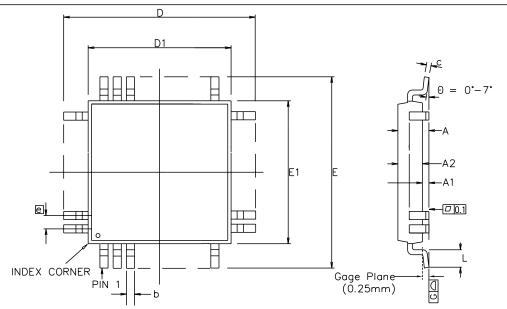
\_\_\_\_

#### Notes:

- 1. Pin 1 indicator may be a corner chamfer, dot or both.
- 2. Controlling dimensions are in millimeters.
- 3. The top package body size may be smaller than the bottom package body size by a max. of 0.15 mm.
- 4. Dimension D1 and E1 do not include mould protusion.
- 5. Dimension b does not include dambar prorusion.
- 6. Coplanarity, measured at seating plane G, to be 0.10 mm max.

This drawing supersedes 418/ED/51210/005 (Swindon)

| © Zarlink Semiconductor 2002 All rights reserved. |         |         |        |         |                        | Package Code                              |
|---|---------|---------|--------|---------|------------------------|---|
| ISSUE   | 2       | 3       | 4      | 5       | Previous package codes | Package Outline for 100 lead              |
| ACN   | 203201  | 204759  | 207063 | 212834  |                        | MQFP (14 x 20 x 2.8mm)<br>3.9mm Footprint |
| DATE  | 200ct97 | 24Jun98 | 1Jul99 | 21May02 | /                      |   |
| APPRD.  |         |         |        |         |                        | GPD00241                                  |



|        | Control D |        |      | Altern. D | imensions |  |  |  |
|--------|-----------|--------|------|-----------|-----------|--|--|--|
| Symbol | in milli  | metres |      | in inches |           |  |  |  |
| ·      | MIN       | MAX    |      | MIN       | MAX       |  |  |  |
| A      |           | 1.60   |      |           | 0.063     |  |  |  |
| A1     | 0.05      | 0.15   |      | 0.002     | 0.006     |  |  |  |
| A2     | 1.35      | 1.45   |      | 0.053     | 0.057     |  |  |  |
| D      | 16.00     | ) BSC  |      | 0.630     | ) BSC     |  |  |  |
| D1     | 14.00     | ) BSC  |      | 0.55      | 1 BSC     |  |  |  |
| E      | 16.00     | ) BSC  |      | 0.630     | ) BSC     |  |  |  |
| E1     | 14.00     | ) BSC  |      | 0.55      | 1 BSC     |  |  |  |
| L      | 0.45      | 0.75   |      | 0.018     | 0.030     |  |  |  |
| е      | 0.50      | ) BSC  |      | 0.020     | ) BSC     |  |  |  |
| b      | 0.17      | 0.27   |      | 0.007     | 0.011     |  |  |  |
| С      | 0.09      | 0.20   |      | 0.004     | 0.008     |  |  |  |
|        |           | Pin    | feat | ures      |           |  |  |  |
| N      |           |        |      |           |           |  |  |  |
| ND     | 25        |        |      |           |           |  |  |  |
| NE     | 25        |        |      |           |           |  |  |  |
| NOTE   |           | SC     | QUA  | RE        |           |  |  |  |

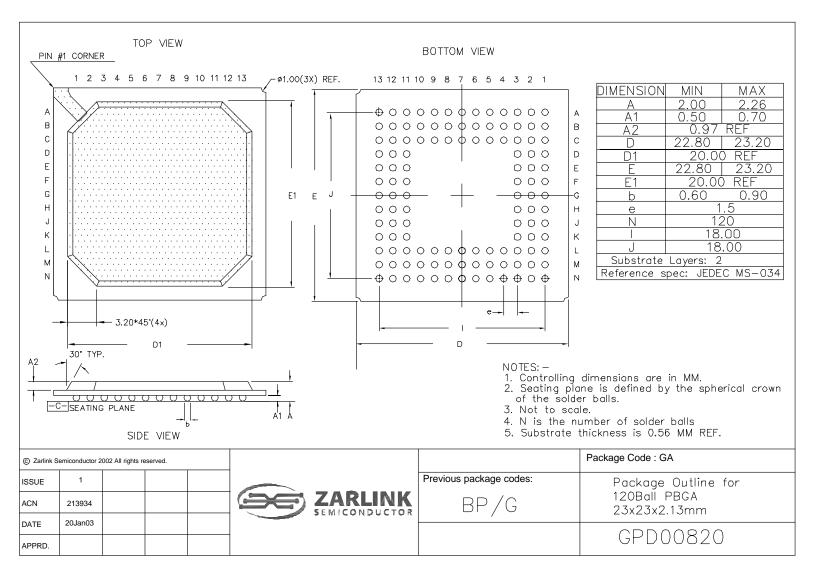
Conforms to JEDEC MS-026 BED Iss. C

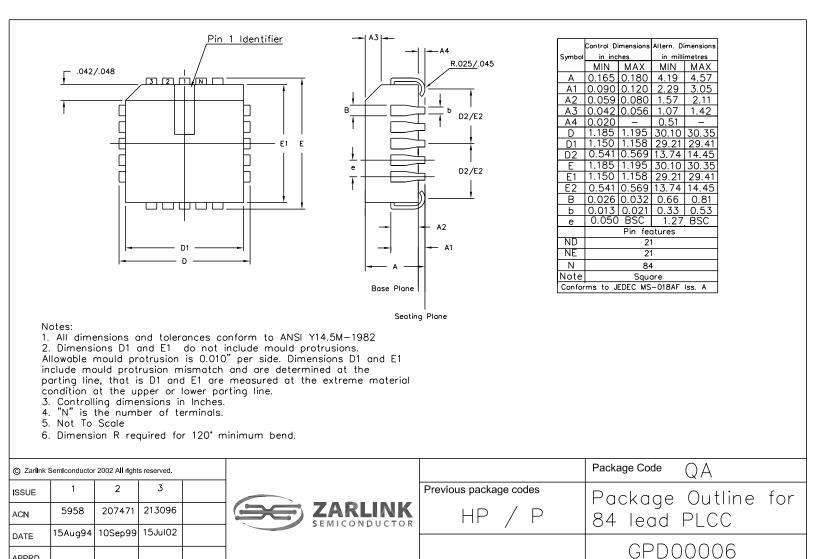
#### Notes:

- 1. Pin 1 indicator may be a corner chamfer, dot or both.
- Controlling dimensions are in millimeters.
   Controlling dimensions are in millimeters.
   The top package body size may be smaller than the bottom package body size by a max. of 0.15 mm.
   Dimension D1 and E1 do not include mould protusion.
   Dimension b does not include dambar protusion.
   Coplanarity, measured at seating plane G, to be 0.08 mm max.

This drawing supersedes 418/ED/51210/023 (Swindon)

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|---|---------|---------|---------|--|---------------|------------------------|---|
| ISSUE   | 1       | 2       | 3       |  |               | Previous package codes | Package Outline for 100 lead              |
| ACN   | 201373  | 207144  | 212447  |  | SEMICONDUCTOR | GP / B                 | LQFP (14 x 14 x 1.4mm)<br>2.0mm Footprint |
| DATE  | 290ct96 | 15Jul99 | 26Mar02 |  |               | ,                      |   |
| APPRD.  |         |         |         |  |               |                        | GPD00253                                  |





APPRD.



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